

C2225C103MHRACTU

Aliases (C2225C103MHRAC7800)

SMD Comm X7R HV, Ceramic, 0.01 uF, 20%, 3,000 VDC, X7R, SMD, MLCC, High Voltage, Temperature Stable, 2225, 3.2 mm



General Information	
Series	SMD Comm X7R HV
Style	SMD Chip
Description	SMD, MLCC, High Voltage, Temperature Stable
Features	High Voltage
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	430 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	2225
L	5.6mm +/-0.4mm
W	6.4mm +/-0.4mm
Т	2mm +/-0.20mm
S	3.2mm MIN
В	0.6mm +/-0.35mm

Packaging

Packaging Quantity

W	6.4mm +/-0.4mm	Toler
Т	2mm +/-0.20mm	Volta
S	3.2mm MIN	Diele
В	0.6mm +/-0.35mm	Tem
		Tem
Packaging Specifications		Capa

500

T&R, 180mm, Plastic Tape

Specifications	
Capacitance	0.01 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	20%
Voltage DC	3000 VDC
Dielectric Withstanding Voltage	3,600 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5%1kHz1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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